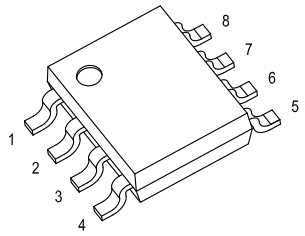
SOP8 Plastic-Encapsulate MOSFETS

ZSQ4606

N-and P-Channel Enhancement Mode Power MOSFET

$V_{(BR)DSS}$	$R_{DS(on)}$TYP	I_D
30V	19mΩ@10V	6.9A
	28mΩ@4.5V	
-30V	29mΩ@-10V	-6.0A
	47mΩ@-4.5V	

SOP8

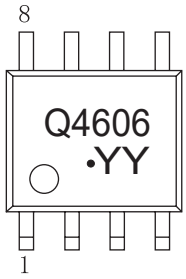


DESCRIPTION

Advance Power MOSFETs provide the designer with the best combination of fast switching, ruggedized device desigh, low on-resistance and cost -effectiveness.

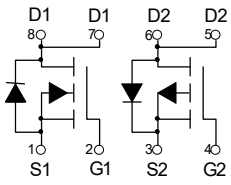
The SOP8 package is widely preferred for commercial-industrial surface mount applications and suited for low voltage applications such as DC/DC converters.

MARKING:



Q4606= Device code
YY=Date Code
Solid dot = Pin1 indicator
Solid dot = Green molding compound device, if none,the normal device.

Equivalent Circuit



Maximum ratings (T_a=25℃ unless otherwise noted)

Parameter Sy	mbol	N-Channel	P-Channel	Unit
Drain-Source Voltage	V_{DS}	30	-30	V
Gate-Source Voltage	V_{GS}	±20	±20	
Continuous Drain Current [a] T_a=25℃	I_D	6.9	-6.0	A
T_a=70℃		5.5	-5	
Pulsed Drain Current [b]	I_{DM}	20	-20	
Power Dissipation	P_D	1.4		W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	89		℃/W
Operating Junction Temperature	T_J	150		℃
Storage Temperature	T_{STG}	-55 ~+150		

Notes :

a. These tests are performed with infinite heat sink.

b.Pulse width by Max.junction temperature.

MOSFET ELECTRICAL CHARACTERISTICS

T_a=25℃ unless otherwise specified

Parameter	Symbol	Test Condition		Min	Typ	Max	Units
Static							
Drain-source breakdown voltage	$V_{(BR)DSS}$	V_{GS}=0, I_D =250μA	N-Ch	30			V
		V_{GS}=0, I_D =-250μA	P-Ch	-30			
Gate-threshold voltage	$V_{GS(th)}$	V_{DS} =V_{GS}, I_D =250μA	N-Ch	1	1.5	3	V
		V_{DS} =V_{GS}, I_D =-250μA	P-Ch	-1	-1.7	-3	
Gate-body leakage	I_{GSS}	V_{DS} =0V, V_{GS} =±20V	N-Ch			±100	nA
			P-Ch				
Zero gate voltage drain current	I_{DSS}	V_{DS} =30V, V_{GS} =0V	N-Ch			1	μA
		V_{DS} =-30V, V_{GS} =0V	P-Ch			-1	
Drain-source on-resistance[c]	$R_{DS(on)}$	V_{GS} =10V, I_D =6A	N-Ch		19	28	mΩ
		V_{GS} =-10V, I_D =-6A	P-Ch		29	36	
		V_{GS} =4.5V, I_D =4A	N-Ch		28	42	
		V_{GS} =-4.5V, I_D =-4A	P-Ch		47	55	
Forward transconductance	g_{fs}	V_{DS} =10V, I_D =6A	N-Ch	4			S
		V_{DS} =-10V, I_D =-6A	P-Ch				
Diode forward voltage[c]	V_{SD}	I_S=1.7A,V_{GS}=0V	N-Ch			1.2	V
		I_S=-1.7A,V_{GS}=0V	P-Ch			-1.2	
Dynamic							
Total gate charge[c]	Q_g	N-Channel V_{DS} =15V,V_{GS} =4.5V,I_D =6A P-Channel V_{DS} =-15V,V_{GS} =-4.5V,I_D =-6A	N-Ch		9.5		nC
			P-Ch		9.5		
Gate-source charge[d]	Q_{gs}		N-Ch		1.5		
			P-Ch		2		
Gate-drain charge[d]	Q_{gd}		N-Ch		3		
			P-Ch		3		
Turn-on delay time[c]	$t_{d(on)}$	N-Channel V_{DS}=15V,R_L=2.2Ω, V_{GS}=10V,R_G=3Ω P-Channel V_{DS}=-15V,R_L=2.7Ω, V_{GS}=-10V,R_G=3Ω	N-Ch		3.3		ns
			P-Ch		7		
Rise time[d]	t_r		N-Ch		4.8		
			P-Ch		3		
Turn-off delay time[d]	$t_{d(off)}$		N-Ch		26		
			P-Ch		20		
Fall time[d]	t_f		N-Ch		4		
			P-Ch		12		
Input Capacitance[d]	C_{iss}	N-Channel V_{DS} =15V,V_{GS} =0V,f =1MHz P-Channel V_{DS} =-15V,V_{GS} =0V,f =1MHz	N-Ch		633		pF
			P-Ch		850		
Output Capacitance[d]	C_{oss}		N-Ch		65		
			P-Ch		101		
Reverse Transfer Capacitance[d]	C_{rss}		N-Ch		55		
			P-Ch		65		

Notes :

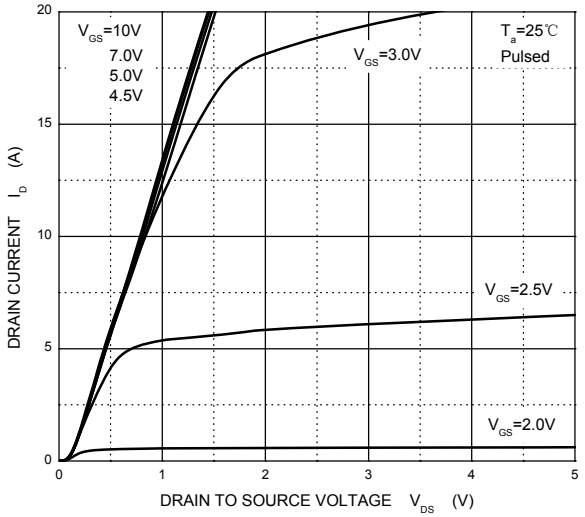
c. Pulse Test : Pulse width≤300μs, duty cycle ≤2%.

d. Guaranteed by design, not subject to production testing.

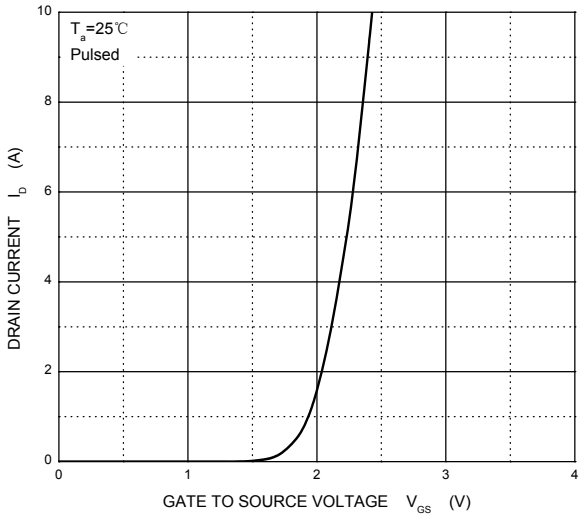
Typical Characteristics

CJQ4606-N-Ch

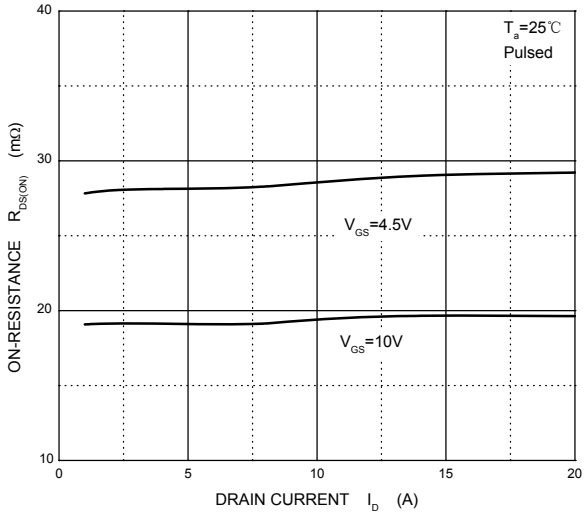
Output Characteristics



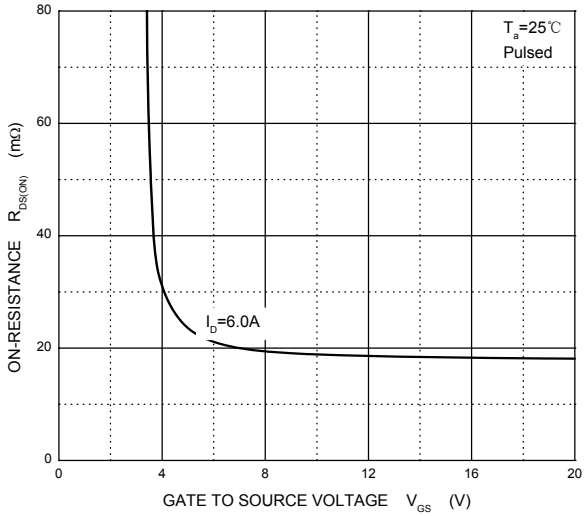
Transfer Characteristics



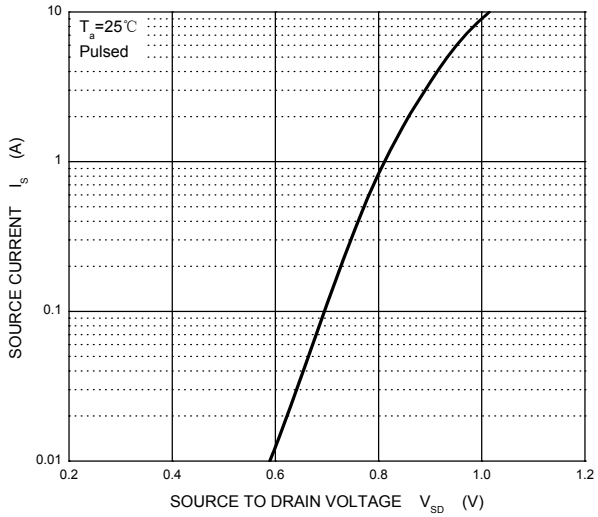
$R_{DS(ON)}$ — I_D



$R_{DS(ON)}$ — V_{GS}



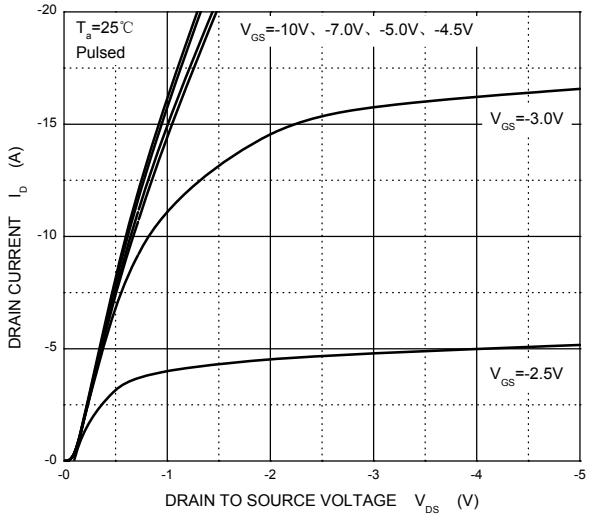
I_S — V_{SD}



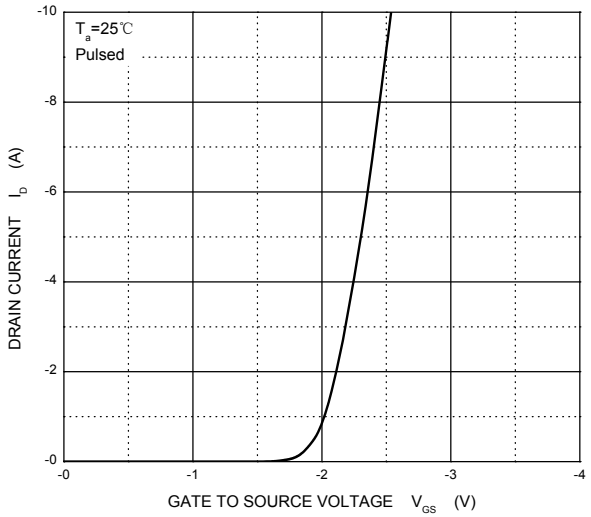
Typical Characteristics

CJQ4606-P-Ch

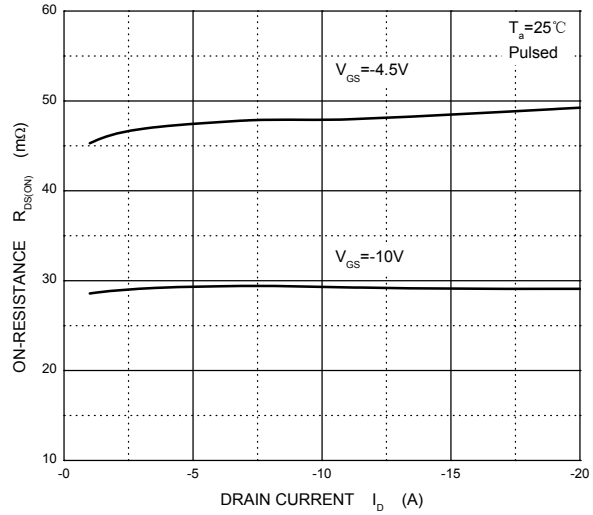
Output Characteristics



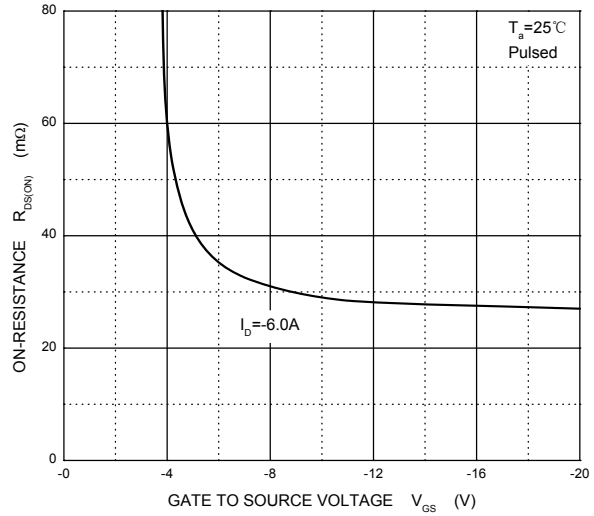
Transfer Characteristics



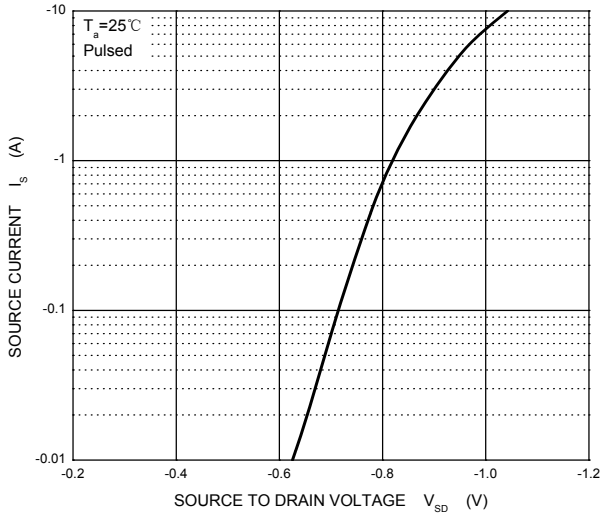
$R_{DS(ON)}$ —— I_D



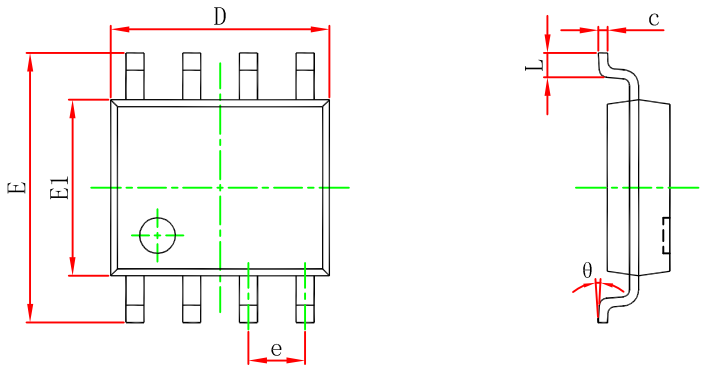
$R_{DS(ON)}$ —— V_{GS}

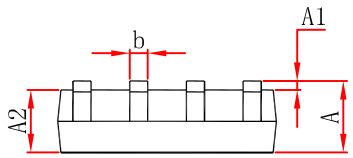


I_S —— V_{SD}



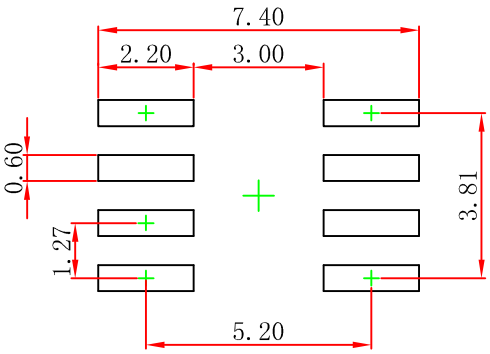
SOP8 Package Outline Dimensions





Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	**Max**	**Min**	**Max**
A	1.450	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.013	0.020
c	0.170	0.250	0.007	0.010
D	4.700	5.100	0.185	0.201
e	1.270（BSC）		0.050（BSC）	
E	5.800	6.200	0.228	0.244
E1	3.800	4.000	0.150	0.157
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

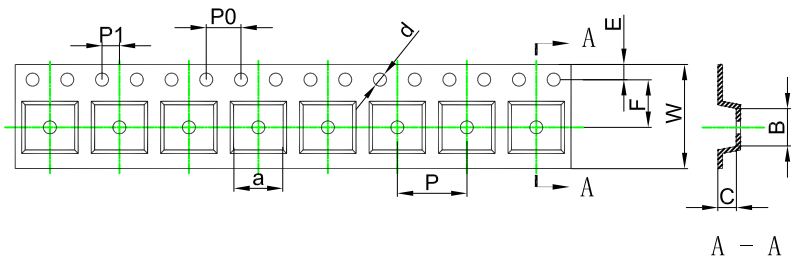
SOP8 Suggested Pad Layout



Note:
1.Controlling dimension:in millimeters.
2.General tolerance:±0.05mm.
3.The pad layout is for reference purposes only.

SOP8 Tape and Reel

SOP8 Embossed Carrier Tape



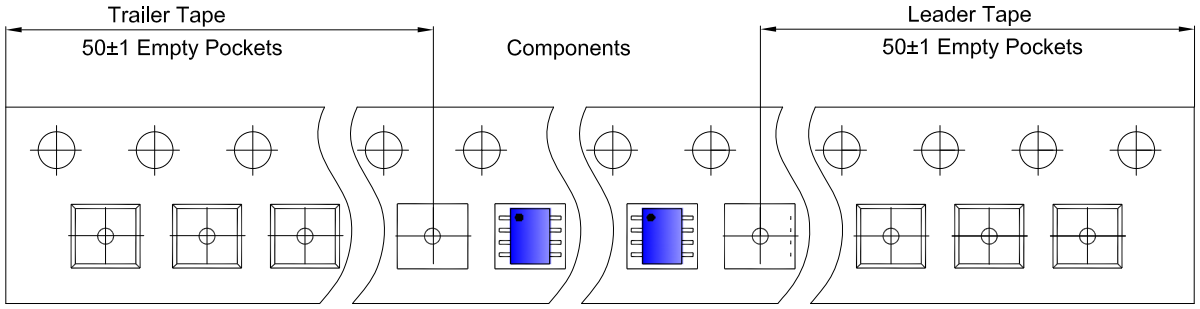
Packaging Description:

SOP8 parts are shipped in tape. The carrier tape is made from a dissipative (carbon filled) polycarbonate resin. The cover tape is a multilayer film (Heat Activated Adhesive in nature) primarily composed of polyester film, adhesive layer, sealant, and anti-static sprayed agent. These reeled parts in standard option are shipped with 4,000 units per 13" or 33cm diameter reel. The reels are clear in color and is made of polystyrene plastic (anti-static coated).

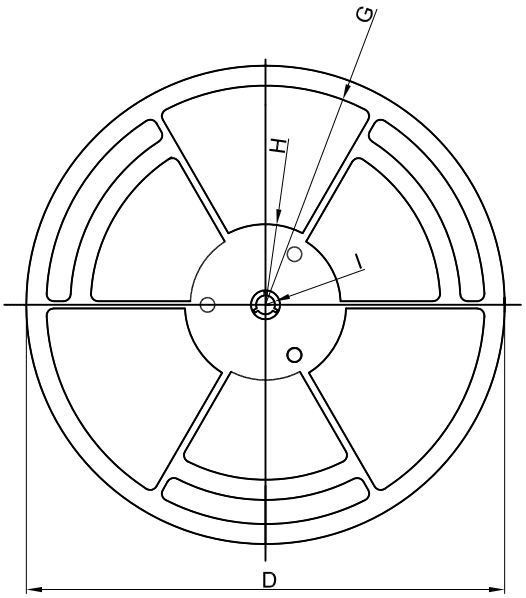
ALL DIM IN mm

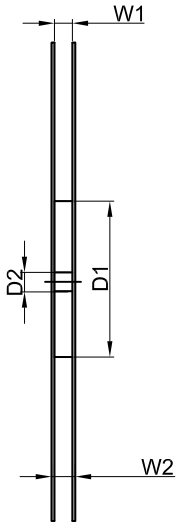
Dimensions are in millimeter										
Pkg type	a	B	C	d	E	F	P0	P	P1	W
SOP8	6.40	5.40	2.10	Ø1.50	1.75	5.50	4.00	8.00	2.00	12.00

SOP8 Tape Leader and Trailer



SOP8 Reel





Dimensions are in millimeter								
Reel Option	D	D1	D2	G	H	I	W1	W2
13"Dia	Ø330.00	100.00	13.00	R151.00	R56.00	R6.50	12.40	17.60

REEL	Reel Size	Box	Box Size(mm)	Carton	Carton Size(mm)	G.W.(kg)
4,000 pcs	13 inch	8,000 pcs	360×360×65	64,000 pcs	565×380×390	